

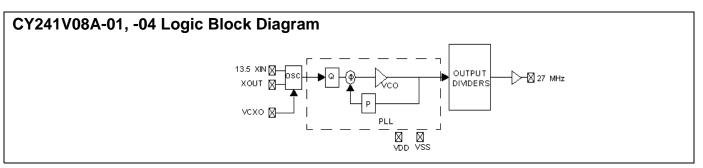
# MPEG Clock Generator with VCXO

### **Features**

- Integrated Phase-Locked Loop (PLL)
- Low Jitter, High Accuracy Outputs
- VCXO with Analog Adjust
- 3.3V Operation
- Compatible with MK3727 (-1, -4)
- Application compatibility for a wide variety of Designs
- Enables Design compatibility
- Lower Drive Strength settings (CY241V08A-04)

### **Benefits**

- Digital VCXO control
- Second source for existing designs
- Highest performance PLL tailored for multimedia applications
- Meets critical timing requirements in complex system designs



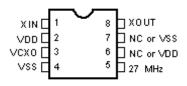
### **Selector Guide**

Part Number	Outputs	Input Frequency Range	Output Frequencies	VCXO Control Curve	Other Features
CY241V08A-01		13.5 MHz pullable crystal input according to Cypress specification	1 copy of 27 MHz	linear	Compatible with MK3727
CY241V08A-04	1	13.5 MHz pullable crystal input according to Cypress specification	1 copy of 27 MHz		Same as CY241V08A-01 except lower drive strength settings



## **Pin Configurations**

Figure 1. CY241V08A-01, -04 8-Pin SOIC



## **Pin Descriptions**

Name	Pin Number	Description	
XIN	1	Reference crystal input	
VDD	2	Voltage supply	
VCXO	3	Input analog control for VCXO	
VSS	4	Ground	
27 MHz	5	MHz clock output	
NC/VDD	6	No connect or voltage supply	
NC/VSS	7	No connect or ground	
XOUT	8	Reference crystal output	



### **Absolute Maximum Conditions**

Exceeding maximum ratings may shorten the useful life of the device. User guidelines are not tested. Supply Voltage (V<sub>DD</sub>)......-0.5 to +7.0V DC Input Voltage .....-0.5V to V<sub>DD</sub> + 0.5 Storage Temperature (Non-condensing) .... -55°C to +125°C

Junction Temperature	-40°C to +125°C
Data Retention at Tj = 125°C	> 10 years
Package Power Dissipation	350 mW
ESD (Human Body Model) MIL-STD-883	> 2000V

### Pullable Crystal Specifications[1]

Parameter	Description	Comments	Min	Тур	Max	Unit
F <sub>NOM</sub>	Nominal crystal frequency	Parallel resonance, fundamental mode, AT cut	_	13.5	_	MHz
C <sub>LNOM</sub>	Nominal load capacitance		_	14	_	pF
R <sub>1</sub>	Equivalent series resistance (ESR)	Fundamental mode	_	_	25	Ω
R <sub>3</sub> /R <sub>1</sub>	Ratio of third overtone mode ESR to fundamental mode ESR	Ratio used because typical R <sub>1</sub> values are much less than the maximum spec	3	_	_	-
DL	Crystal drive level	No external series resistor assumed	150	_	_	μW
F <sub>3SEPHI</sub>	Third overtone separation from 3*F <sub>NOM</sub>	High side	300	_	_	ppm
F <sub>3SEPLO</sub>	Third overtone separation from 3*F <sub>NOM</sub>	Low side	-	_	-150	ppm
C <sub>0</sub>	Crystal shunt capacitance		_	_	7	pF
C <sub>0</sub> /C <sub>1</sub>	Ratio of shunt to motional capacitance		180	_	250	-
C <sub>1</sub>	Crystal motional capacitance		14.4	18	21.6	fF

## **Recommended Operating Conditions**

Parameter	Description	Min	Тур	Max	Unit
$V_{DD}$	Operating Voltage	3.135	3.3	3.465	V
T <sub>A</sub>	Ambient Temperature	0	_	70	C
C <sub>LOAD</sub>	Maximum Load Capacitance	_	_	15	pF
t <sub>PU</sub>	Power up time for all VDD pins to reach minimum specified voltage (power ramps must be monotonic)	0.05	_	500	ms

## **DC Electrical Specifications**

Parameter	Name	Description	Min	Тур	Max	Unit
I <sub>OH</sub>	Output HIGH Current	$V_{OH} = V_{DD} - 0.5V, V_{DD} = 3.3V$	12	24	_	mA
I <sub>OL</sub>	Output LOW Current	$V_{OL} = 0.5 V, V_{DD} = 3.3 V$	12	24	_	mA
C <sub>IN</sub>	Input Capacitance	Except XIN, XOUT pins	_	_	7	pF
V <sub>VCXO</sub>	VCXO Input Range		0	_	$V_{DD}$	V
$f_{\Delta XO}^{[2]}$	VCXO Pullability Range	Low Side	_	_	-115	ppm
		High Side	115	_	_	ppm
I <sub>VDD</sub>	Supply Current		_	30	35	mA

#### Notes

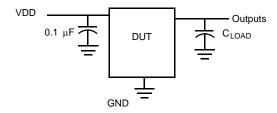
- 1. Crystals that meet this specification include: Ecliptek ECX-5788-13.500M, Siward XTL001050A-13.5-14-400, Raltron A-13.500-14-CL,PDI HA13500XFSA14XC.
- -115/+115 ppm assumes 2.5 pF of additional board level load capacitance. This range will be shifted down with more board capacitance or shifted up with less board capacitance.



## AC Electrical Specifications $(V_{DD} = 3.3V)^{[3]}$

Parameter <sup>[3]</sup>	Name	Description	Min	Тур	Max	Unit
DC	Output Duty Cycle	Duty Cycle is defined in Figure 2, 50% of V <sub>DD</sub>	45	50	55	%
ER <sub>OR</sub>	Rising Edge Rate –01	Output Clock Edge Rate, Measured from 20% to 80% of V <sub>DD</sub> , CLOAD = 15 pF See Figure 3.	0.8	1.4	_	V/ns
ER <sub>OF</sub>	Falling Edge Rate –01	Output Clock Edge Rate, Measured from 80% to 20% of V <sub>DD</sub> , CLOAD = 15 pF See Figure 3.	0.8	1.4	_	V/ns
ER <sub>OR</sub>	Rising Edge Rate –04	Output Clock Edge Rate, Measured from 20% to 80% of V <sub>DD</sub> , CLOAD = 15 pF See Figure 3.	0.7	1.1	_	V/ns
ER <sub>OF</sub>	Falling Edge Rate –04	Output Clock Edge Rate, Measured from 80% to 20% of V <sub>DD</sub> , CLOAD = 15 pF See Figure 3.	0.7	1.1	_	V/ns
t <sub>9</sub>	Clock Jitter	Peak-to-peak period jitter	_	_	100	ps
t <sub>10</sub>	PLL Lock Time		1	_	3	ms

## **Test and Measurement Setup**



## **Voltage and Timing Definitions**

Figure 2. Duty Cycle Definition

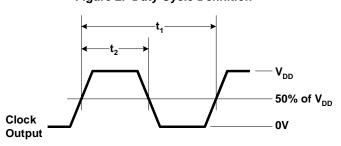
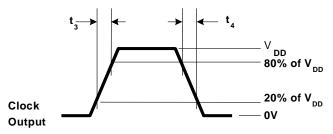


Figure 3. ER =  $(0.6 \text{ x V}_{DD})/t_3$ , EF =  $(0.6 \text{ x V}_{DD})/t_4$ 



### Note

3. Not 100% tested.

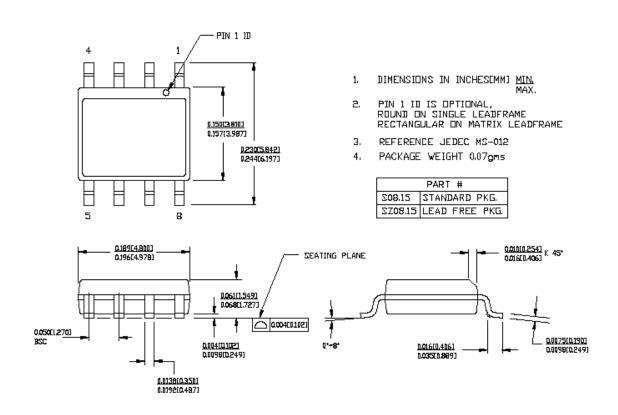


## **Ordering Information**

Ordering Code	Package Type	Operating Range	Operating Voltage	Features
Pb-free				
CY241V8ASXC-01	8-pin SOIC	Commercial	3.3V	Linear VCXO control curve
CY241V8ASXC-01T	8-pin SOIC -Tape and Reel	Commercial	3.3V	Linear VCXO control curve
Pure Sn		•	•	
CY241V8ASXC-1S	8-pin SOIC	Commercial	3.3V	Linear VCXO control curve

## **Package Drawing and Dimensions**

Figure 4. 8-Pin (150-Mil) SOIC



51-85066 \*D



### **Document History Page**

REV.	ECN NO.	Submission Date	Orig. of Change	Description of Change
**	214069	See ECN	RGL	New Data Sheet
*A	220404	See ECN	RGL	Minor Change: To post on web
*B	393122	See ECN	RGL	Added Lead-free device for -01 Added the CY241V8A-01 in the title
*C	414184	See ECN	RGL	Minor Change: Deleted unnecessary text in the benefit section
*D	455059	See ECN	RGL	Added Pure Sn parts for -01
*E	2759384	09/02/2009	TSAI	Updated template Post to external web
*F	2897423	03/22/10	CXQ	Updated ordering information table. Removed part numbers, CY241V08ASC-01, CY241V08ASC-01T, CY241V08ASC-04, and CY241V08ASC-04T Updated package diagram. Updated copyright section.

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